

# SSR4N60B / SSU4N60B

## **600V N-Channel MOSFET**

#### **General Description**

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology.

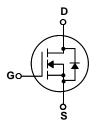
This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies.

#### **Features**

- 2.8A, 600V,  $R_{DS(on)}$  = 2.5 $\Omega$  @V<sub>GS</sub> = 10 V Low gate charge ( typical 22 nC)
- Low Crss (typical 14 pF)
- Fast switching
- 100% avalanche tested
- · Improved dv/dt capability







# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter		SSR4N60B / SSU4N60B	Units
$V_{DSS}$	Drain-Source Voltage		600	V
I <sub>D</sub>	Drain Current - Continuous (T <sub>C</sub> = 25°	°C)	2.8	А
	- Continuous (T <sub>C</sub> = 100	O°C)	1.8	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	11.2	А
$V_{GSS}$	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	240	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	2.8	Α
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	4.9	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P <sub>D</sub>	Power Dissipation (T <sub>A</sub> = 25°C) *		2.5	W
	Power Dissipation (T <sub>C</sub> = 25°C)		49	W
	- Derate above 25°C		0.39	W/°C
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Temperature Rai	nge	-55 to +150	°C
T <sub>L</sub>	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

# **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		2.56	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

Symbol	Parameter	Test Conditions	3	Min	Тур	Max	Units
Off Cha	racteristics						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600			V
ΔBV <sub>DSS</sub> / ΔΤ <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, Referenced	I to 25°C	-	0.65		V/°C
I <sub>DSS</sub>	7 0 1 1/1 5 1 0 1	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V				10	μΑ
	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 480 V, T <sub>C</sub> = 125°C	)			100	μΑ
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$		2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.4 A	-	2.0	2.5	Ω	
9FS	Forward Transconductance	V <sub>DS</sub> = 40 V, I <sub>D</sub> = 1.4 A	(Note 4)		3.7		S
C <sub>iss</sub>	ic Characteristics Input Capacitance	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V,			710	920	pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		65	85	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance		1	14	19	рF	
Switchi	ng Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time	V 200 V I 40 A			20	50	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 300 \text{ V}, I_{D} = 4.0 \text{ A},$ $R_{G} = 25 \Omega$			55	120	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	NG - 20 22			70	150	ns
t <sub>f</sub>	Turn-Off Fall Time		(Note 4, 5)		55	120	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 480 V, I <sub>D</sub> = 4.0 A,			22	29	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V		-	4.8		nC
Q <sub>gd</sub>	Gate-Drain Charge		(Note 4, 5)	-	8.5		nC
Drain-S	ource Diode Characteristics a	nd Maximum Rating	s				
I <sub>S</sub>	Maximum Continuous Drain-Source Did					2.8	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode F	orward Current				11.2	Α
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2.8 \text{ A}$				1.4	V
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 4.0 \text{ A},$			330		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dI <sub>F</sub> / dt = 100 A/μs	(Note 4)		2.67		μС

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 56mH, I<sub>AS</sub> = 2.8A, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25  $\Omega$ , Starting T<sub>J</sub> = 25°C 3. I<sub>SD</sub>  $\leq$  4.0A, di/dt  $\leq$  300A/μs, V<sub>DD</sub>  $\leq$  BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C 4. Pulse Test : Pulse width  $\leq$  300μs, Duty cycle  $\leq$  2% 5. Essentially independent of operating temperature

# **Typical Characteristics**

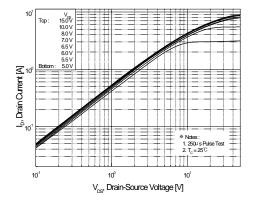


Figure 1. On-Region Characteristics

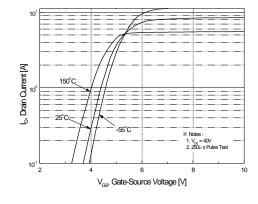


Figure 2. Transfer Characteristics

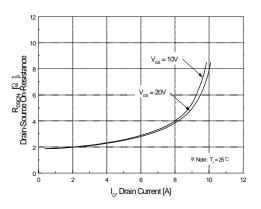


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

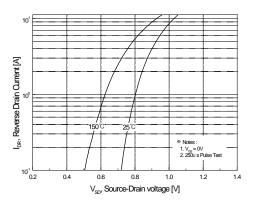


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

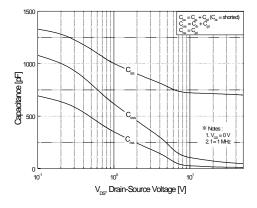


Figure 5. Capacitance Characteristics

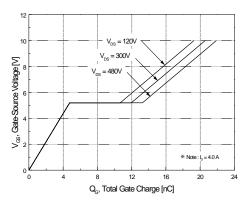


Figure 6. Gate Charge Characteristics

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# Typical Characteristics (Continued)

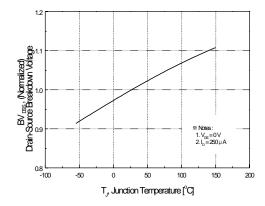


Figure 7. Breakdown Voltage Variation vs Temperature

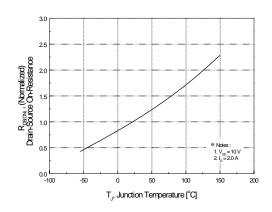


Figure 8. On-Resistance Variation vs Temperature

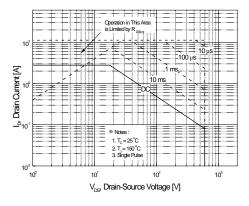


Figure 9. Maximum Safe Operating Area

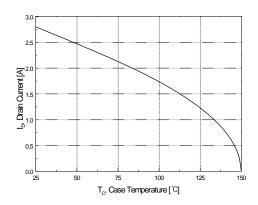


Figure 10. Maximum Drain Current vs Case Temperature

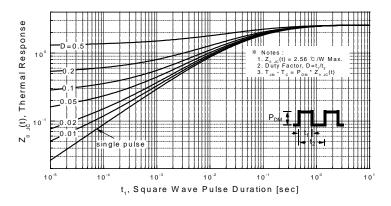
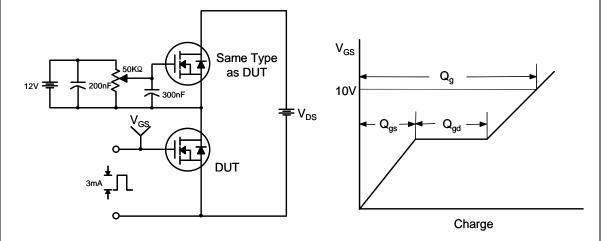


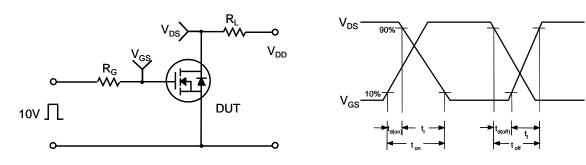
Figure 11. Transient Thermal Response Curve

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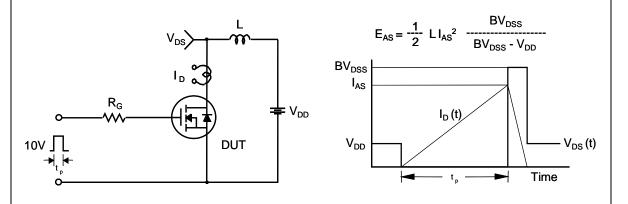
# **Gate Charge Test Circuit & Waveform**



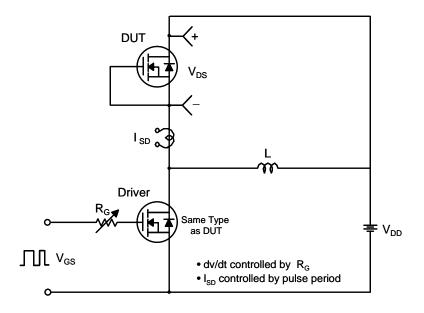
## **Resistive Switching Test Circuit & Waveforms**

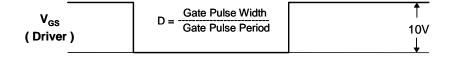


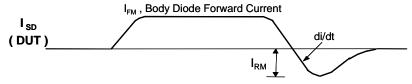
## **Unclamped Inductive Switching Test Circuit & Waveforms**



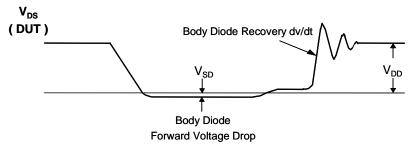
#### Peak Diode Recovery dv/dt Test Circuit & Waveforms

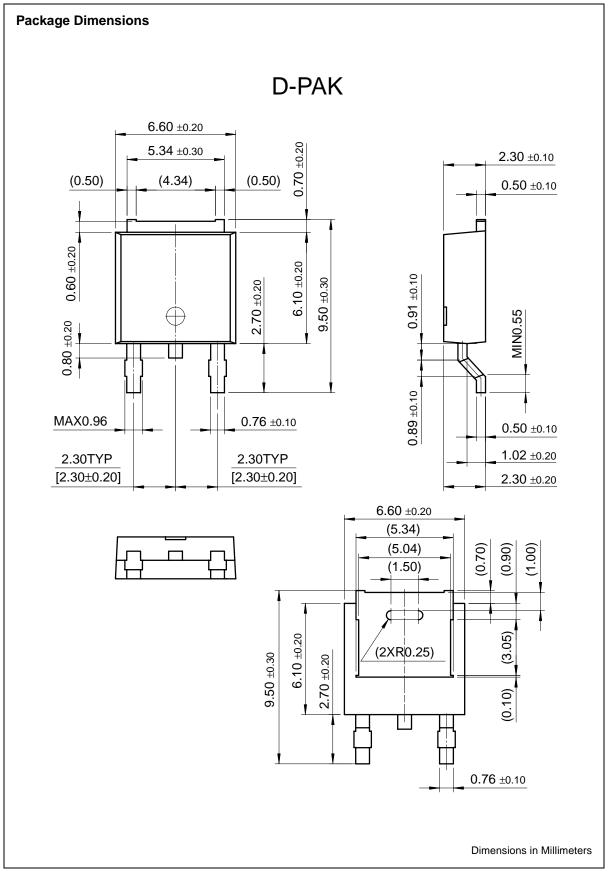


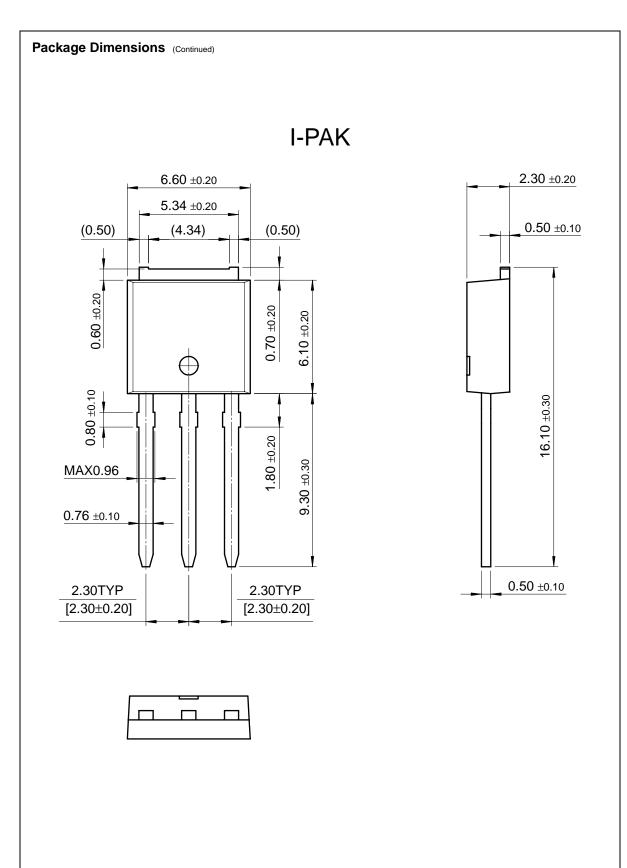




Body Diode Reverse Current







Dimensions in Millimeters

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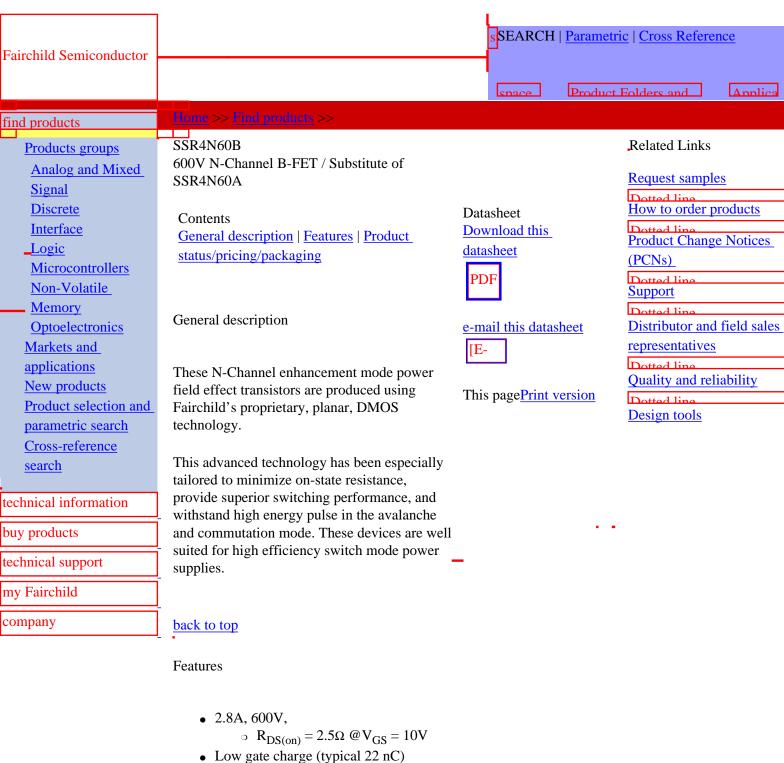
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Datasheet Identification	Product Status	Definition
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- Low Crss (typical 14 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Packing method
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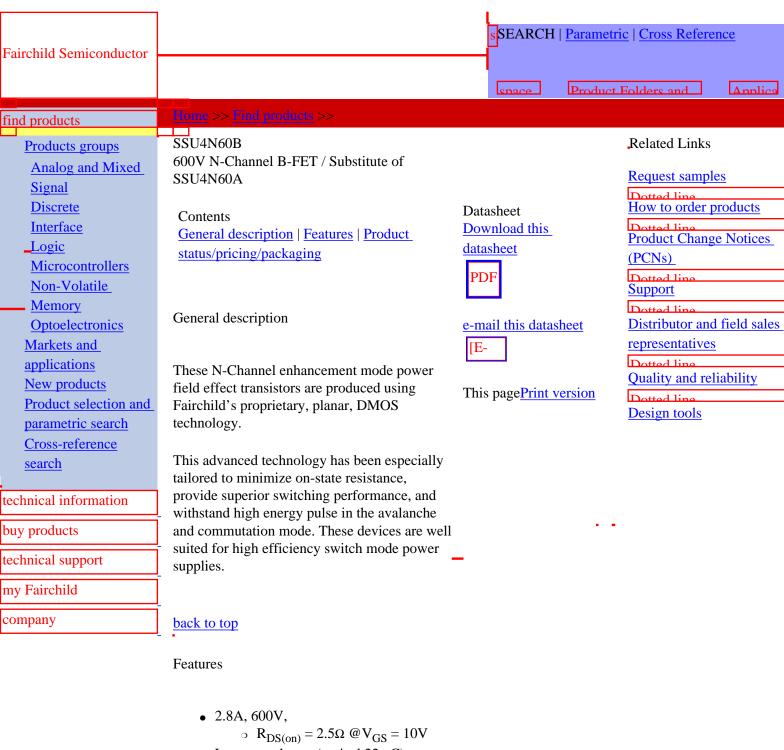
SSR4N60BTM	Full Production	\$0.59	TO-252(DPAK)	2	TAPE REEL
SSR4N60BTF	Full Production	\$0.59	TO-252(DPAK)	2	TAPE REEL

<sup>\* 1,000</sup> piece Budgetary Pricing

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- Low gate charge (typical 22 nC)
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Product status/pricing/packaging

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Product	Product status	Pricing*	Package type	Leads	Packing method
	,	,			

Product Folder - Fairchild P/N SSU4N60B - 600V N-Channel B-FET / Substitute of SSU4N60A

SSU4N60BTU	Full Production	\$0.59	TO-251(IPAK)	3	RAIL

<sup>\* 1,000</sup> piece Budgetary Pricing

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